## In the Claims

Claims 8 and 9 have been canceled, new claim 26 has been added, and claim 1 has been amended as follows:

(Currently amended) A method for removing contaminate particulate matter 1. from a contaminate particle containing substrate surface comprising the steps of: applying a sacrificial coating of a material to a substrate surface containing undesirable particulate matter thereon, which material is to encapsulate and suspend the undesirable particles therein; fluidizing the material if necessary; applying energy to the coated substrate to dislodge at least some of the particulate matter from the surface of the substrate into the fluid sacrificial coating such that the particulate matter is partially or fully encapsulated and suspended within the sacrificial coating forming a particulate matter containing sacrificial material coating; and forming the fluidized particulate matter containing sacrificial material coating into a strippable film; and removing the particulate matter containing sacrificial material coating strippable film from the substrate surface providing a substrate surface

having less particulate matter thereon.

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- 1 2. (original) The method of claim 1 wherein the substrate is a semiconductor
- 2 wafer.
- 1 3. (original) The method of claim 1 wherein the sacrificial coating material is
- 2 a fluid.
- 1 4. (original) The method of claim 1 wherein the energy used is sonic energy.
- 1 5. (original) The method of claim 1 wherein the energy used is thermal,
- 2 centrifugal, magnetic or vibrational.
- 1 6. (original) The method of claim 1 wherein the sacrificial coating material is
- 2 a liquid.
- 1 7. (original) The method of claim 1 wherein the sacrificial coating material is
- 2 a curable polymer.
- 1 8.-9. (canceled)
- 1 10. (original) The method of claim 1 wherein the material is a gas, liquid,
- 2 vapor or fluid polymer.

1 11.-25. (Withdrawn)

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- 26. (New) The method of claim 1 wherein the strippable film is formed
- 2 simultaneously with application of the energy to dislodge the particles.